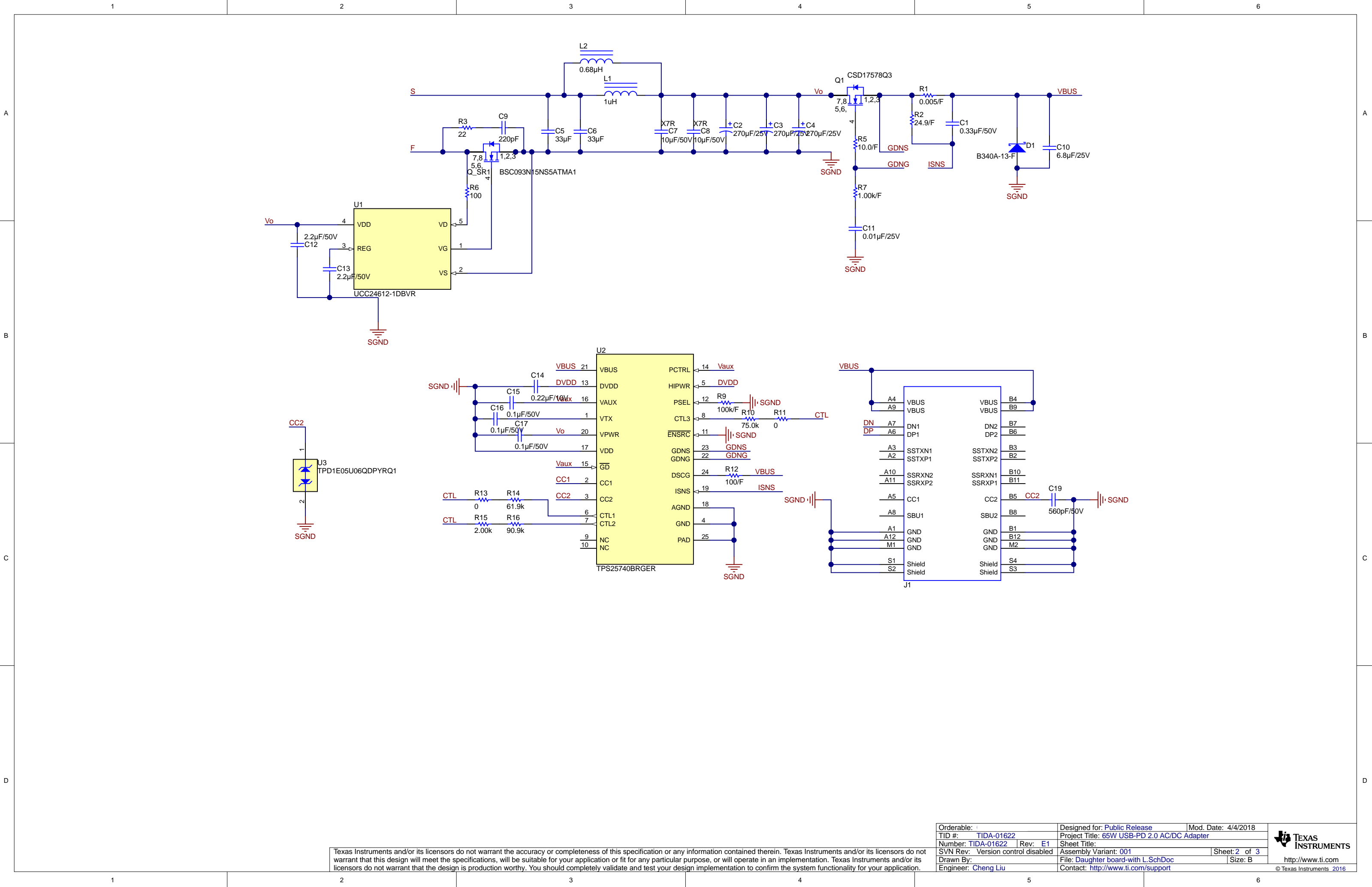


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Orderable:	Designed for: Public Release	Mod. Date: 4/4/2018
TID #: TIDA-01622	Project Title: 65W USB-PD 2.0 AC/DC Adapter	
Number: TIDA-01622	Rev: E1	Sheet Title:
SVN Rev: Version control disabled	Assembly Variant: 001	Sheet: 2 of 3
Drawn By:	File: Mother board_SchDoc	Size: B
Engineer: Cheng Liu	Contact: <a href="http://www.ti.com/support">http://www.ti.com/support</a>	



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Orderable:	Designed for: Public Release	Mod. Date: 4/4/2018
TID #: TIDA-01622	Project Title: 65W USB-PD 2.0 AC/DC Adapter	
Number: TIDA-01622	Rev: E1	Sheet Title:
SVN Rev: Version control disabled	Assembly Variant: 001	Sheet: 2 of 3
Drawn By:	File: Daughter board-with L_SchDoc	Size: B
Engineer: Cheng Liu	Contact: http://www.ti.com/support	

A

A

B

B

C

C

D

D

PCB Number: TIDA-01622  
PCB Rev: E1

PCB  
LOGO  
Texas Instruments

PCB  
LOGO  
Pb-Free Symbol

PCB  
LOGO  
FCC disclaimer

Variant/Label Table	
Variant	Label Text
001	ChangeMe!
002	ChangeMe!

LBL1

PCB Label

Size: 0.65" x 0.20 "

ZZ1

Label Assembly Note

This Assembly Note is for PCB labels only

ZZ2

### Assembly Note

These assemblies are ESD sensitive, ESD precautions shall be observed.

ZZ3


Assembly Note

These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

ZZ4

### Assembly Note

These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

Orderable:	Designed for: <a href="#">Public Release</a>	Mod. Date: 4/4/2018	 <b>TEXAS INSTRUMENTS</b>  <a href="http://www.ti.com">http://www.ti.com</a> © Texas Instruments 2016
TID #: <a href="#">TIDA-01622</a>	Project Title: <a href="#">65W USB-PD 2.0 AC/DC Adapter</a>		
Number: <a href="#">TIDA-01622</a> Rev: <a href="#">E1</a>	Sheet Title:		
SVN Rev: Version control disabled	Assembly Variant: <a href="#">001</a>	Sheet: <a href="#">4</a> of <a href="#">4</a>	
Drawn By:	File: <a href="#">EVM_Hardware Sheet.SchDoc</a>	Size: B	
Engineer: <a href="#">Cheng Liu</a>	Contact: <a href="http://www.ti.com/support">http://www.ti.com/support</a>		

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